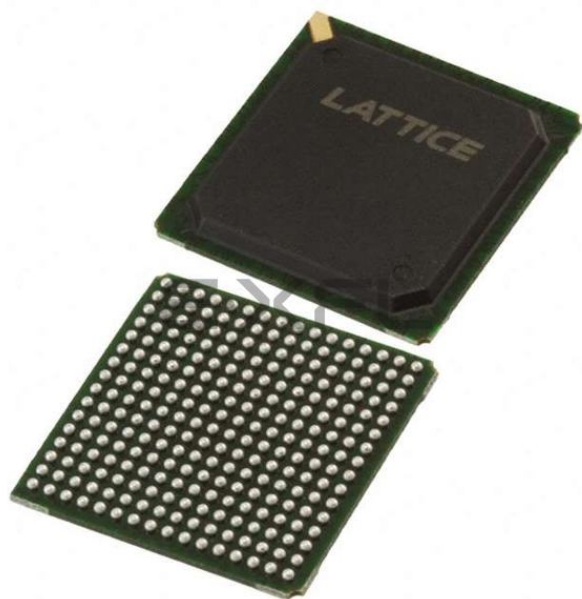




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Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Obsolete
Number of LABs/CLBs	-
Number of Logic Elements/Cells	6100
Total RAM Bits	94208
Number of I/O	195
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	256-BGA
Supplier Device Package	256-FPBGA (17x17)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfec6e-3fn256c

Figure 2-1. Simplified Block Diagram, LatticeEC Device (Top Level)

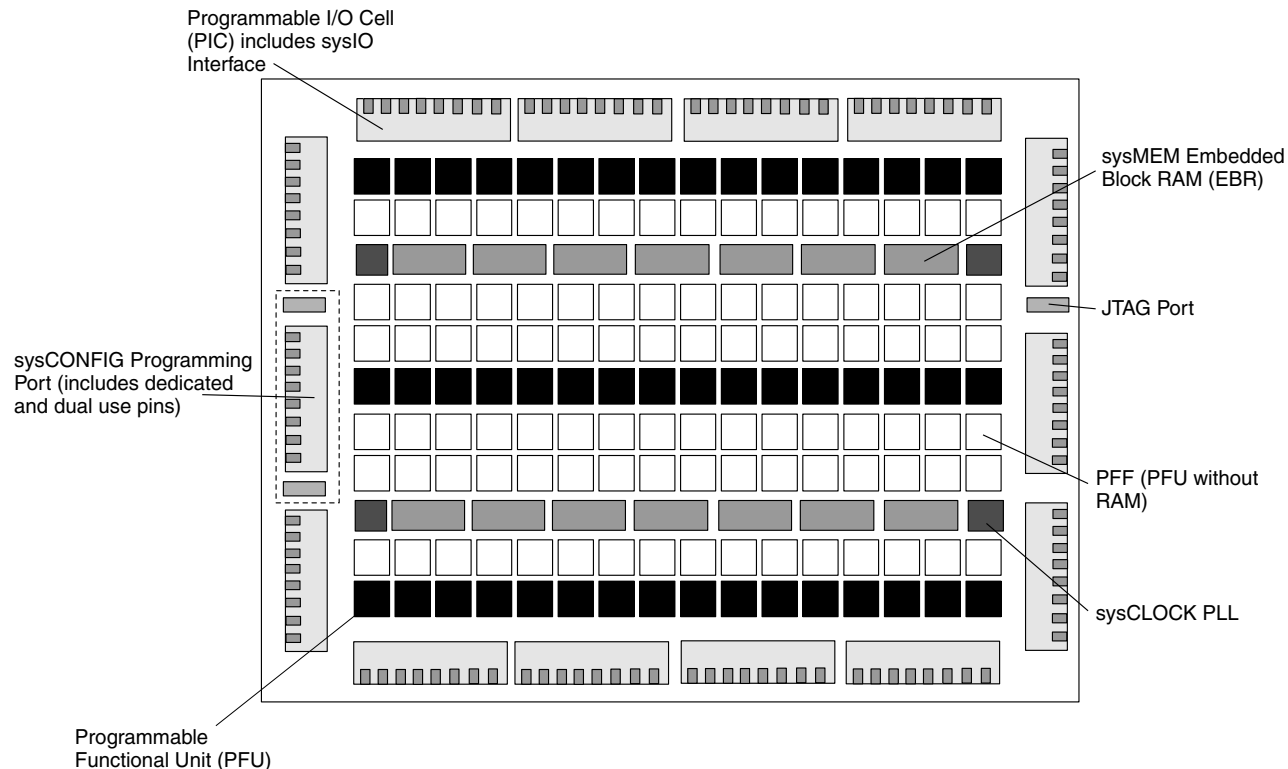
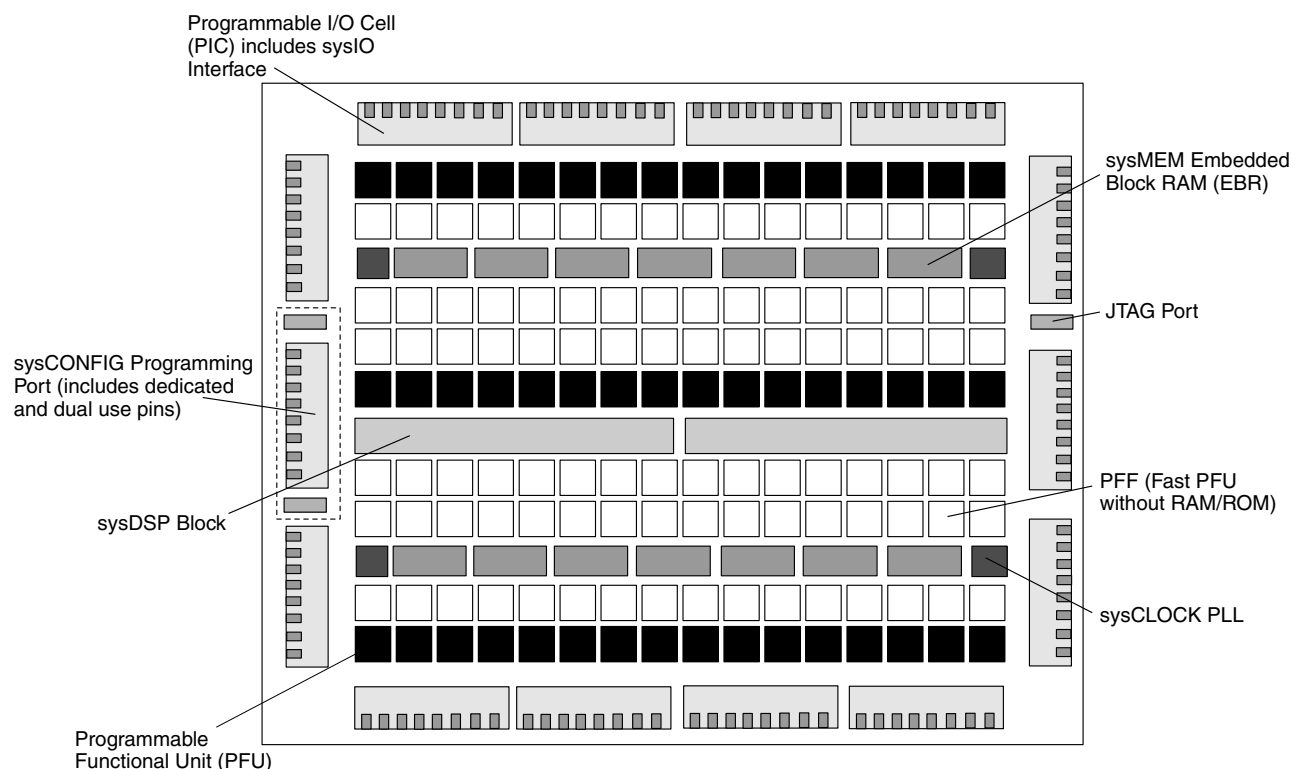


Figure 2-2. Simplified Block Diagram, LatticeECP-DSP Device (Top Level)



Input Register Block

The input register block contains delay elements and registers that can be used to condition signals before they are passed to the device core. Figure 2-26 shows the diagram of the input register block.

Input signals are fed from the sysI/O buffer to the input register block (as signal DI). If desired the input signal can bypass the register and delay elements and be used directly as a combinatorial signal (INDD), a clock (INCK) and in selected blocks the input to the DQS delay block. If one of the bypass options is not chosen, the signal first passes through an optional delay block. This delay, if selected, reduces input-register hold-time requirement when using a global clock.

The input block allows two modes of operation. In the single data rate (SDR) the data is registered, by one of the registers in the single data rate sync register block, with the system clock. In the DDR Mode two registers are used to sample the data on the positive and negative edges of the DQS signal creating two data streams, D0 and D2. These two data streams are synchronized with the system clock before entering the core. Further discussion on this topic is in the DDR Memory section of this data sheet.

Figure 2-27 shows the input register waveforms for DDR operation and Figure 2-28 shows the design tool primitives. The SDR/SYNC registers have reset and clock enable available.

The signal DDRCLKPOL controls the polarity of the clock used in the synchronization registers. It ensures adequate timing when data is transferred from the DQS to system clock domain. For further discussion on this topic, see the DDR Memory section of this data sheet.

Figure 2-26. Input Register Diagram

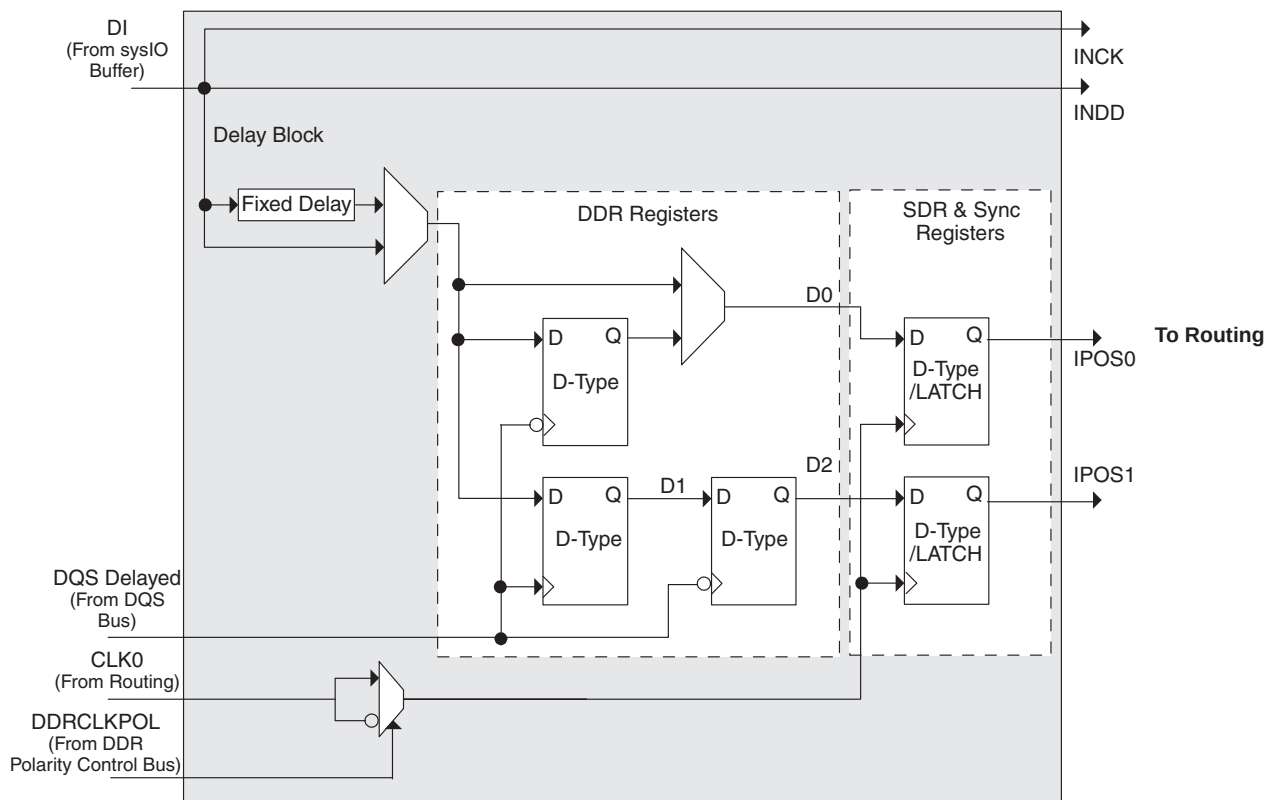


Table 2-14. Supported Output Standards

Output Standard	Drive	V _{CCIO} (Nom.)
Single-ended Interfaces		
LVTTTL	4mA, 8mA, 12mA, 16mA, 20mA	3.3
LVC MOS33	4mA, 8mA, 12mA 16mA, 20mA	3.3
LVC MOS25	4mA, 8mA, 12mA, 16mA, 20mA	2.5
LVC MOS18	4mA, 8mA, 12mA, 16mA	1.8
LVC MOS15	4mA, 8mA	1.5
LVC MOS12	2mA, 6mA	1.2
LVC MOS33, Open Drain	4mA, 8mA, 12mA 16mA, 20mA	—
LVC MOS25, Open Drain	4mA, 8mA, 12mA 16mA, 20mA	—
LVC MOS18, Open Drain	4mA, 8mA, 12mA 16mA	—
LVC MOS15, Open Drain	4mA, 8mA	—
LVC MOS12, Open Drain	2mA, 6mA	—
PCI33	N/A	3.3
HSTL18 Class I, II, III	N/A	1.8
HSTL15 Class I, III	N/A	1.5
SSTL3 Class I, II	N/A	3.3
SSTL2 Class I, II	N/A	2.5
SSTL18 Class I	N/A	1.8
Differential Interfaces		
Differential SSTL3, Class I, II	N/A	3.3
Differential SSTL2, Class I, II	N/A	2.5
Differential SSTL18, Class I	N/A	1.8
Differential HSTL18, Class I, II, III	N/A	1.8
Differential HSTL15, Class I, III	N/A	1.5
LVDS	N/A	2.5
BLVDS ¹	N/A	2.5
LVPECL ¹	N/A	3.3
RSDS ¹	N/A	2.5

1. Emulated with external resistors.

Hot Socketing

The LatticeECP/EC devices have been carefully designed to ensure predictable behavior during power-up and power-down. Power supplies can be sequenced in any order. During power up and power-down sequences, the I/Os remain in tristate until the power supply voltage is high enough to ensure reliable operation. In addition, leakage into I/O pins is controlled within specified limits, this allows for easy integration with the rest of the system. These capabilities make the LatticeECP/EC ideal for many multiple power supply and hot-swap applications.

Configuration and Testing

The following section describes the configuration and testing features of the LatticeECP/EC devices.

IEEE 1149.1-Compliant Boundary Scan Testability

All LatticeECP/EC devices have boundary scan cells that are accessed through an IEEE 1149.1 compliant test access port (TAP). This allows functional testing of the circuit board, on which the device is mounted, through a serial scan path that can access all critical logic nodes. Internal registers are linked internally, allowing test data to

Oscillator

Every LatticeECP/EC device has an internal CMOS oscillator which is used to derive a master clock for configuration. The oscillator and the master clock run continuously. The default value of the master clock is 2.5MHz. Table 2-15 lists all the available Master Clock frequencies. When a different Master Clock is selected during the design process, the following sequence takes place:

1. User selects a different Master Clock frequency.
2. During configuration the device starts with the default (2.5MHz) Master Clock frequency.
3. The clock configuration settings are contained in the early configuration bit stream.
4. The Master Clock frequency changes to the selected frequency once the clock configuration bits are received.

For further information about the use of this oscillator for configuration, please see the list of technical documentation at the end of this data sheet.

Table 2-15. Selectable Master Clock (CCLK) Frequencies During Configuration

CCLK (MHz)	CCLK (MHz)	CCLK (MHz)
2.5*	13	45
4.3	15	51
5.4	20	55
6.9	26	60
8.1	30	130
9.2	34	—
10.0	41	—

Density Shifting

The LatticeECP/EC family has been designed to ensure that different density devices in the same package have the same pin-out. Furthermore, the architecture ensures a high success rate when performing design migration from lower density parts to higher density parts. In many cases, it is also possible to shift a lower utilization design targeted for a high-density device to a lower density device. However, the exact details of the final resource utilization will impact the likely success in each case.

DC Electrical Characteristics

Over Recommended Operating Conditions

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
I_{IL}, I_{IH}^1	Input or I/O Leakage	$0 \leq V_{IN} \leq (V_{CCIO} - 0.2V)$	—	—	10	μA
$I_{IH}^{1,3}$	Input or I/O High Leakage	$(V_{CCIO} - 0.2V) \leq V_{IH} \leq 3.6V$	—	—	40	μA
I_{PU}	I/O Active Pull-up Current	$0 \leq V_{IN} \leq 0.7 V_{CCIO}$	-30	—	-150	μA
I_{PD}	I/O Active Pull-down Current	$V_{IL} (MAX) \leq V_{IN} \leq V_{IH} (MAX)$	30	—	150	μA
I_{BHLS}	Bus Hold Low sustaining current	$V_{IN} = V_{IL} (MAX)$	30	—	—	μA
I_{BHHS}	Bus Hold High sustaining current	$V_{IN} = 0.7V_{CCIO}$	-30	—	—	μA
I_{BHLO}	Bus Hold Low Overdrive current	$0 \leq V_{IN} \leq V_{IH} (MAX)$	—	—	150	μA
I_{BHLH}	Bus Hold High Overdrive current	$0 \leq V_{IN} \leq V_{IH} (MAX)$	—	—	-150	μA
V_{BHT}	Bus Hold trip Points	$0 \leq V_{IN} \leq V_{IH} (MAX)$	$V_{IL} (MAX)$	—	$V_{IH} (MIN)$	V
C1	I/O Capacitance ²	$V_{CCIO} = 3.3V, 2.5V, 1.8V, 1.5V, 1.2V,$ $V_{CC} = 1.2V, V_{IO} = 0 \text{ to } V_{IH} (MAX)$	—	8	—	pf
C2	Dedicated Input Capacitance ²	$V_{CCIO} = 3.3V, 2.5V, 1.8V, 1.5V, 1.2V,$ $V_{CC} = 1.2V, V_{IO} = 0 \text{ to } V_{IH} (MAX)$	—	6	—	pf

1. Input or I/O leakage current is measured with the pin configured as an input or as an I/O with the output driver tri-stated. It is not measured with the output driver active. Bus maintenance circuits are disabled.

2. T_A 25°C, $f = 1.0MHz$

3. For top and bottom general purpose I/O pins, when V_{IH} is higher than V_{CCIO} , a transient current typically of 30ns in duration or less with a peak current of 6mA can occur on the high-to-low transition. For left and right I/O banks, V_{IH} must be less than or equal to V_{CCIO} .

Differential HSTL and SSTL

Differential HSTL and SSTL outputs are implemented as a pair of complementary single-ended outputs. All allowable single-ended output classes (class I and class II) are supported in this mode.

LVDS25E

The top and bottom side of LatticeECP/EC devices support LVDS outputs via emulated complementary LVCMOS outputs in conjunction with a parallel resistor across the driver outputs. The scheme shown in

Figure 3-1 is one possible solution for point-to-point signals.

Figure 3-1. LVDS25E Output Termination Example

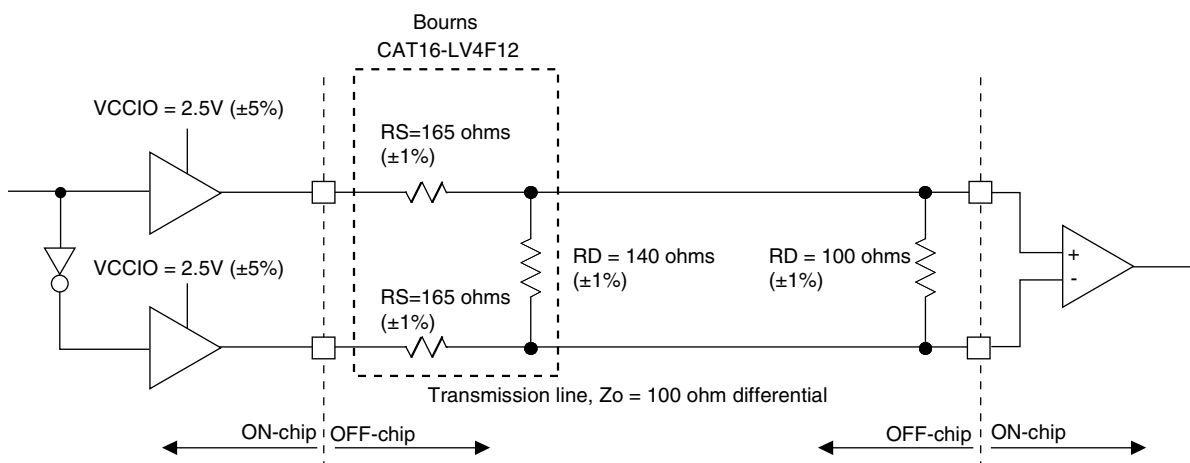


Table 3-1. LVDS25E DC Conditions

Parameter	Description	Typical	Units
V_{OH}	Output high voltage	1.42	V
V_{OL}	Output low voltage	1.08	V
V_{OD}	Output differential voltage	0.35	V
V_{CM}	Output common mode voltage	1.25	V
Z_{BACK}	Back impedance	100	$\%$

LVPECL

The LatticeECP/EC devices support differential LVPECL standard. This standard is emulated using complementary LVCMOS outputs in conjunction with a parallel resistor across the driver outputs. The LVPECL input standard is supported by the LVDS differential input buffer. The scheme shown in Figure 3-3 is one possible solution for point-to-point signals.

Figure 3-3. Differential LVPECL

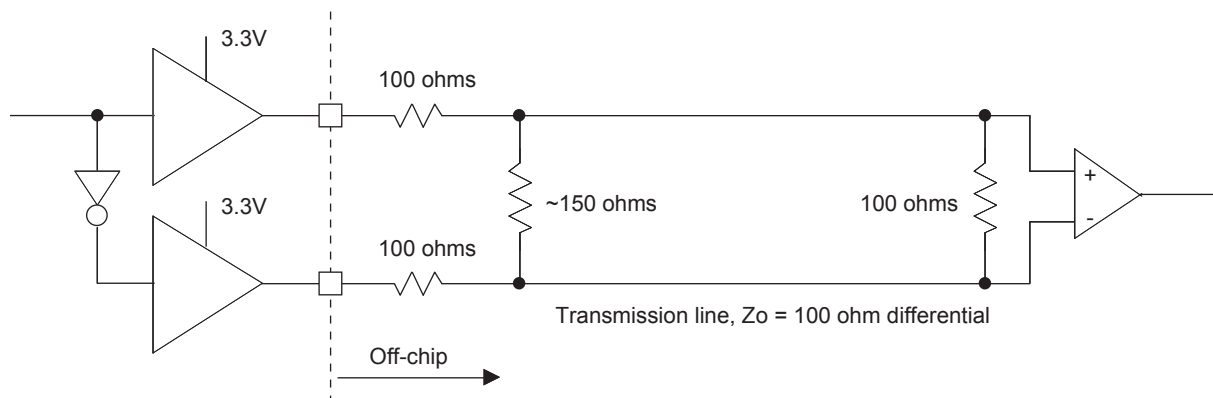


Table 3-3. LVPECL DC Conditions¹

Over Recommended Operating Conditions

Parameter	Description	Typical	Units
Z_{OUT}	Output impedance	100	ohm
R_P	Driver parallel resistor	150	ohm
R_T	Receiver termination	100	ohm
V_{OH}	Output high voltage	2.03	V
V_{OL}	Output low voltage	1.27	V
V_{OD}	Output differential voltage	0.76	V
V_{CM}	Output common mode voltage	1.65	V
Z_{BACK}	Back impedance	85.7	ohm
I_{DC}	DC output current	12.7	mA

1. For input buffer, see LVDS table.

For further information about LVPECL, BLVDS and other differential interfaces please see the list of technical information at the end of this data sheet.

Figure 3-14. sysCONFIG Master Serial Port Timing

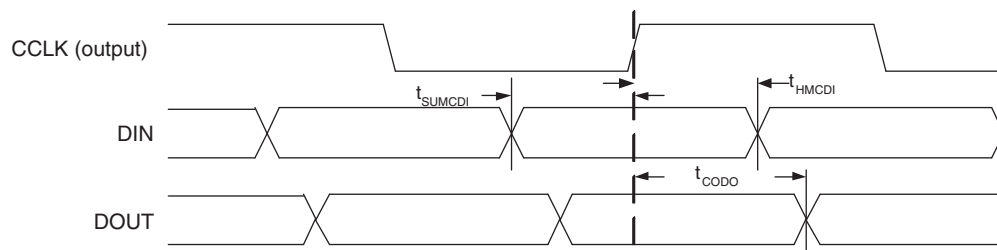


Figure 3-15. sysCONFIG Slave Serial Port Timing

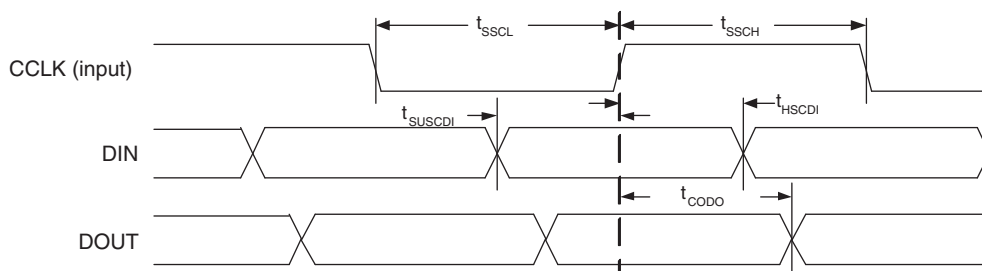
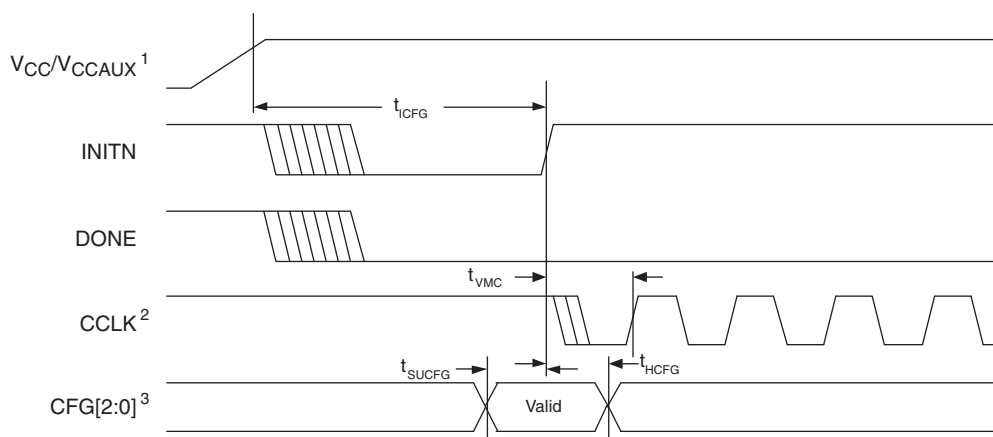


Figure 3-16. Power-On-Reset (POR) Timing



1. Time taken from V_{CC} or V_{CCAUX} , whichever is the last to reach its V_{MIN} .
2. Device is in a Master Mode.
3. The CFG pins are normally static (hard wired).

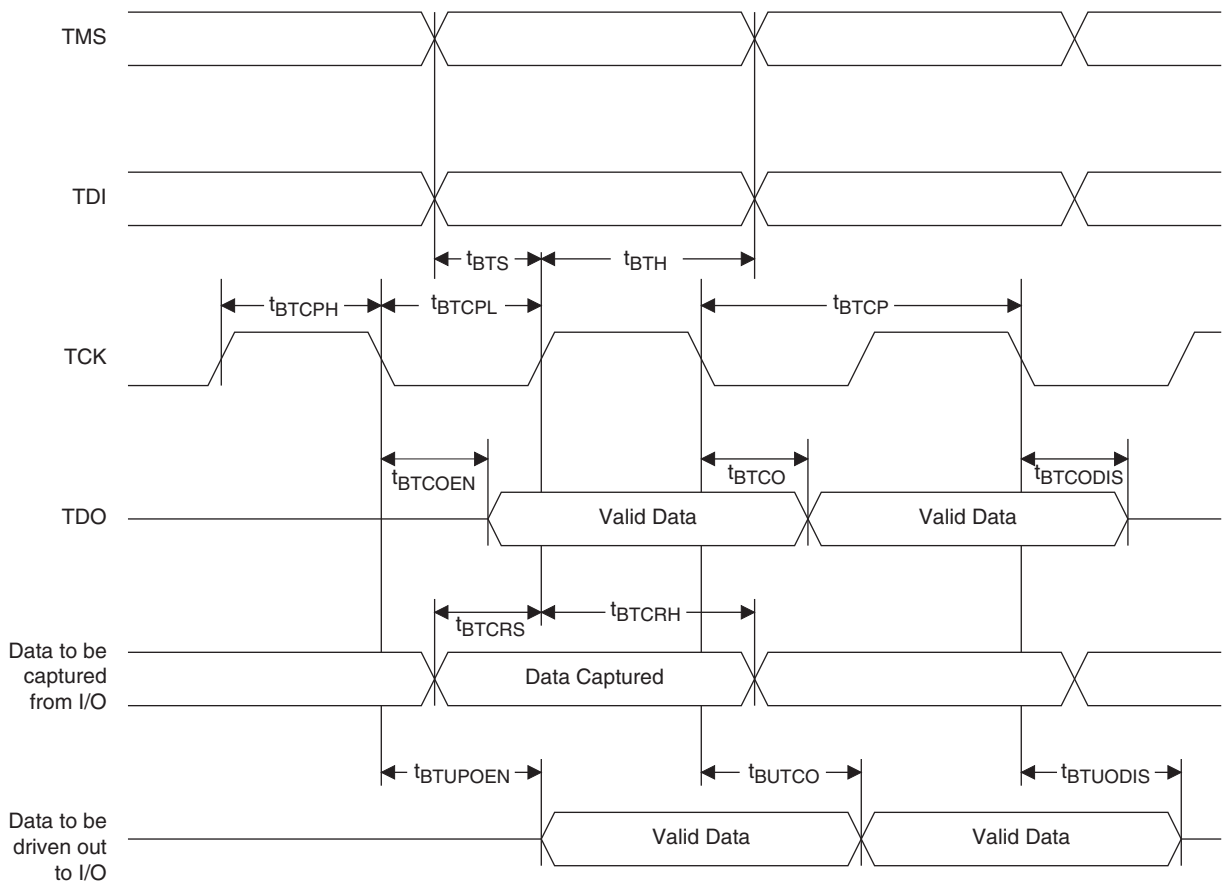
JTAG Port Timing Specifications

Over Recommended Operating Conditions

Symbol	Parameter	Min	Max	Units
f_{MAX}	TCK clock frequency	—	25	MHz
t_{BTCP}	TCK [BSCAN] clock pulse width	40	—	ns
t_{BTCPH}	TCK [BSCAN] clock pulse width high	20	—	ns
t_{BTCPL}	TCK [BSCAN] clock pulse width low	20	—	ns
t_{BTS}	TCK [BSCAN] setup time	8	—	ns
t_{BTH}	TCK [BSCAN] hold time	10	—	ns
t_{BTRF}	TCK [BSCAN] rise/fall time	50	—	mV/ns
t_{BTCO}	TAP controller falling edge of clock to valid output	—	10	ns
t_{BTCODIS}	TAP controller falling edge of clock to valid disable	—	10	ns
t_{BTCOEN}	TAP controller falling edge of clock to valid enable	—	10	ns
t_{BTCRS}	BSCAN test capture register setup time	8	—	ns
t_{BTCRH}	BSCAN test capture register hold time	25	—	ns
t_{BUTCO}	BSCAN test update register, falling edge of clock to valid output	—	25	ns
t_{BTUODIS}	BSCAN test update register, falling edge of clock to valid disable	—	25	ns
t_{BTUPOEN}	BSCAN test update register, falling edge of clock to valid enable	—	25	ns

Timing v.G 0.30

Figure 3-20. JTAG Port Timing Waveforms



Pin Information Summary

		LFEC1			LFEC3				LFEC6/EC6				LFEC6/EC10		
Pin Type		100-TQFP	144-TQFP	208-PQFP	100-TQFP	144-TQFP	208-PQFP	256-fpBGA	144-TQFP	208-PQFP	256-fpBGA	484-fpBGA	208-PQFP	256-fpBGA	484-fpBGA
Single Ended User I/O		67	97	112	67	97	145	160	97	147	195	224	147	195	288
Differential Pair User I/O		29	46	56	29	46	72	80	46	72	97	112	72	97	144
Configu-ration	Dedicated	13	13	13	13	13	13	13	13	13	13	13	13	13	13
	Muxed	48	48	48	48	48	48	48	48	48	48	48	56	56	56
TAP		5	5	5	5	5	5	5	5	5	5	5	5	5	5
Dedicated (total without supplies)		80	110	160	80	110	160	208	110	160	208	373	160	208	373
V _{CC}		2	3	3	2	3	3	10	4	4	10	20	6	10	20
V _{CCAUX}		2	2	2	4	4	4	4	2	4	2	12	4	2	12
V _{CCPLL}		0	0	0	0	0	0	0	0	0	0	0	0	0	0
V _{CCIO}	Bank0	1	2	2	1	2	3	2	2	3	2	4	3	2	4
	Bank1	1	2	2	1	2	2	2	2	2	2	4	2	2	4
	Bank2	1	1	1	2	2	2	2	1	2	2	4	2	2	4
	Bank3	1	2	2	1	2	2	2	2	2	2	4	2	2	4
	Bank4	1	2	2	1	2	2	2	2	2	2	4	2	2	4
	Bank5	1	2	2	1	2	2	2	2	3	2	4	3	2	4
	Bank6	1	2	2	1	2	2	2	2	2	2	4	2	2	4
	Bank7	1	1	1	2	2	2	2	1	2	2	4	2	2	4
GND, GND0-GND7		8	13	13	8	13	16	20	14	18	20	44	20	20	44
NC		0	2	51	0	2	9	35	0	4	0	139	0	0	75
Single Ended/Differential I/O Pair per Bank	Bank 0	11/5	14/7	16/8	11/5	14/7	26/13	32/16	14/7	26/13	32/16	32/16	26/13	32/16	48/24
	Bank 1	11/5	13/6	16/8	11/5	13/6	16/8	16/8	13/6	17/8	18/9	32/16	17/8	18/9	32/16
	Bank 2	3/1	8/4	8/4	3/1	8/4	14/7	16/8	8/4	14/7	16/8	16/8	14/7	16/8	32/16
	Bank 3	8/4	13/6	16/8	8/4	13/6	16/8	16/8	13/6	16/8	32/16	32/16	16/8	32/16	32/16
	Bank 4	12/4	14/6	16/8	12/4	14/6	16/8	16/8	14/6	17/8	17/8	32/16	17/8	17/8	32/16
	Bank 5	9/4	13/6	16/8	9/4	13/6	26/13	32/16	13/6	26/13	32/16	32/16	26/13	32/16	48/24
	Bank 6	5/2	14/7	16/8	5/2	14/7	16/8	16/8	14/7	16/8	32/16	32/16	16/8	32/16	32/16
	Bank 7	8/4	8/4	8/4	8/4	8/4	15/7	16/8	8/4	15/7	16/8	16/8	15/7	16/8	32/16
V _{CCJ}		1	1	1	1	1	1	1	1	1	1	1	1	1	1

Note: During configuration the user-programmable I/Os are tri-stated with an internal pull-up resistor enabled. If any pin is not used (or not bonded to a package pin), it is also tri-stated with an internal pull-up resistor enabled after configuration.

LFEC6P/EC6, LFEC6P/EC10 Logic Signal Connections: 208 PQFP (Cont.)

Pin Number	LFEC6P/EC6				LFEC6P/EC10			
	Pin Function	Bank	LVDS	Dual Function	Pin Function	Bank	LVDS	Dual Function
85	VCCIO4	4			VCCIO4	4		
86	PB18A	4	T	WRITEN	PB26A	4	T	WRITEN
87	PB18B	4	C	CS1N	PB26B	4	C	CS1N
88	PB19A	4	T	VREF1_4	PB27A	4	T	VREF1_4
89	PB19B	4	C	CSN	PB27B	4	C	CSN
90	PB20A	4	T	VREF2_4	PB28A	4	T	VREF2_4
91	PB20B	4	C	D0/SPID7	PB28B	4	C	D0/SPID7
92	PB21A	4	T	D2/SPID5	PB29A	4	T	D2/SPID5
93	GND4	4			GND4	4		
94	PB21B	4	C	D1/SPID6	PB29B	4	C	D1/SPID6
95	PB22A	4	T	BDQS22	PB30A	4	T	BDQS30
96	PB22B	4	C	D3/SPID4	PB30B	4	C	D3/SPID4
97	PB23A	4	T		PB31A	4	T	
98	PB23B	4	C	D4/SPID3	PB31B	4	C	D4/SPID3
99	PB24A	4	T		PB32A	4	T	
100	PB24B	4	C	D5/SPID2	PB32B	4	C	D5/SPID2
101	PB25A	4	T		PB33A	4	T	
102	PB25B	4	C	D6/SPID1	PB33B	4	C	D6/SPID1
103	PB33A	4			PB41A	4		
104	VCCIO4	4			VCCIO4	4		
105*	GND3 GND4	-			GND3 GND4	-		
106	VCCIO3	3			VCCIO3	3		
107	PR27B	3	C	VREF2_3	PR36B	3	C	VREF2_3
108	PR27A	3	T	VREF1_3	PR36A	3	T	VREF1_3
109	PR26B	3	C		PR35B	3	C	
110	PR26A	3	T		PR35A	3	T	
111	PR25B	3	C		PR34B	3	C	
112	PR25A	3	T		PR34A	3	T	
113	PR24B	3	C		PR33B	3	C	
114	PR24A	3	T	RDQS24	PR33A	3	T	RDQS33
115	PR23B	3	C	RLM0_PLLC_FB_A	PR32B	3	C	RLM0_PLLC_FB_A
116	GND3	3			GND3	3		
117	PR23A	3	T	RLM0_PLLT_FB_A	PR32A	3	T	RLM0_PLLT_FB_A
118	PR22B	3	C	RLM0_PLLC_IN_A	PR31B	3	C	RLM0_PLLC_IN_A
119	PR22A	3	T	RLM0_PLLT_IN_A	PR31A	3	T	RLM0_PLLT_IN_A
120	VCCIO3	3			VCCIO3	3		
121	PR21B	3	C	DI/CSSPIN	PR30B	3	C	DI/CSSPIN
122	PR21A	3	T	DOUT/CSON	PR30A	3	T	DOUT/CSON
123	PR20B	3	C	BUSY/SISPI	PR29B	3	C	BUSY/SISPI
124	PR20A	3	T	D7/SPID0	PR29A	3	T	D7/SPID0
125	CFG2	3			CFG2	3		
126	CFG1	3			CFG1	3		

LFEC3 and LFECP/EC6 Logic Signal Connections: 256 fpBGA (Cont.)

Ball Number	LFEC3				LFECP6/LFEC6			
	Ball Function	Bank	LVDS	Dual Function	Ball Function	Bank	LVDS	Dual Function
GND	GND5	5			GND5	5		
T9	PB13B	5	C		PB13B	5	C	
P8	PB14A	5	T	BDQS14	PB14A	5	T	BDQS14
N8	PB14B	5	C		PB14B	5	C	
R9	PB15A	5	T		PB15A	5	T	
R10	PB15B	5	C		PB15B	5	C	
P9	PB16A	5	T	VREF2_5	PB16A	5	T	VREF2_5
N9	PB16B	5	C	VREF1_5	PB16B	5	C	VREF1_5
T10	PB17A	5	T	PCLKT5_0	PB17A	5	T	PCLKT5_0
GND	GND5	5			GND5	5		
T11	PB17B	5	C	PCLKC5_0	PB17B	5	C	PCLKC5_0
T12	PB18A	4	T	WRITEN	PB18A	4	T	WRITEN
T13	PB18B	4	C	CS1N	PB18B	4	C	CS1N
P10	PB19A	4	T	VREF1_4	PB19A	4	T	VREF1_4
N10	PB19B	4	C	CSN	PB19B	4	C	CSN
T14	PB20A	4	T	VREF2_4	PB20A	4	T	VREF2_4
T15	PB20B	4	C	D0/SPID7	PB20B	4	C	D0/SPID7
M10	PB21A	4	T	D2/SPID5	PB21A	4	T	D2/SPID5
GND	GND4	4			GND4	4		
M11	PB21B	4	C	D1/SPID6	PB21B	4	C	D1/SPID6
R11	PB22A	4	T	BDQS22	PB22A	4	T	BDQS22
P11	PB22B	4	C	D3/SPID4	PB22B	4	C	D3/SPID4
R13	PB23A	4	T		PB23A	4	T	
R14	PB23B	4	C	D4/SPID3	PB23B	4	C	D4/SPID3
P12	PB24A	4	T		PB24A	4	T	
P13	PB24B	4	C	D5/SPID2	PB24B	4	C	D5/SPID2
N11	PB25A	4	T		PB25A	4	T	
-	-	-			GND4	4		
N12	PB25B	4	C	D6/SPID1	PB25B	4	C	D6/SPID1
R12	NC	-			PB26A	4		
GND	GND4	4			GND4	4		
-	-	-			GND4	4		
GND	GND3	3			GND3	3		
N13	PR18B	3	C	VREF2_3	PR27B	3	C	VREF2_3
N14	PR18A	3	T	VREF1_3	PR27A	3	T	VREF1_3
P14	PR17B	3	C		PR26B	3	C	
P15	PR17A	3	T		PR26A	3	T	
R15	PR16B	3	C		PR25B	3	C	
R16	PR16A	3	T		PR25A	3	T	
M13	PR15B	3	C		PR24B	3	C	
M14	PR15A	3	T	RDQS15	PR24A	3	T	RDQS24
P16	PR14B	3	C	RLM0_PLLC_FB_A	PR23B	3	C	RLM0_PLLC_FB_A
GND	GND3	3			GND3	3		

LFEC3 and LFECP/EC6 Logic Signal Connections: 256 fpBGA (Cont.)

Ball Number	LFEC3				LFECP6/LFEC6			
	Ball Function	Bank	LVDS	Dual Function	Ball Function	Bank	LVDS	Dual Function
N16	PR14A	3	T	RLM0_PLLT_FB_A	PR23A	3	T	RLM0_PLLT_FB_A
N15	PR13B	3	C	RLM0_PLLC_IN_A	PR22B	3	C	RLM0_PLLC_IN_A
M15	PR13A	3	T	RLM0_PLLT_IN_A	PR22A	3	T	RLM0_PLLT_IN_A
M16	PR12B	3	C	DI/CSSPIN	PR21B	3	C	DI/CSSPIN
L16	PR12A	3	T	DOUT/CSON	PR21A	3	T	DOUT/CSON
K16	PR11B	3	C	BUSY/SISPI	PR20B	3	C	BUSY/SISPI
J16	PR11A	3	T	D7/SPID0	PR20A	3	T	D7/SPID0
L12	CFG2	3			CFG2	3		
L14	CFG1	3			CFG1	3		
L13	CFG0	3			CFG0	3		
K13	PROGRAMN	3			PROGRAMN	3		
L15	CCLK	3			CCLK	3		
K15	INITN	3			INITN	3		
K14	DONE	3			DONE	3		
	-	-			GND3	3		
H16	NC	-			PR18B	3	C	
H15	NC	-			PR18A	3	T	
G16	NC	-			PR17B	3	C	
G15	NC	-			PR17A	3	T	
K12	NC	-			PR16B	3	C	
J12	NC	-			PR16A	3	T	
J14	NC	-			PR15B	3	C	
J15	NC	-			PR15A	3	T	RDQS15
F16	NC	-			PR14B	3	C	
-	-	-			GND3	3		
F15	NC	-			PR14A	3	T	
J13	NC	-			PR13B	3	C	
H13	NC	-			PR13A	3	T	
H14	NC	-			PR12B	3	C	
G14	NC	-			PR12A	3	T	
E16	NC	-			PR11B	3	C	
E15	NC	-			PR11A	3	T	
H12	PR9B	2	C	PCLKC2_0	PR9B	2	C	PCLKC2_0
GND	GND2	2			GND2			
G12	PR9A	2	T	PCLKT2_0	PR9A	2	T	PCLKT2_0
G13	PR8B	2	C		PR8B	2	C	
F13	PR8A	2	T		PR8A	2	T	
F12	PR7B	2	C		PR7B	2	C	
E13	PR7A	2	T		PR7A	2	T	
D16	PR6B	2	C		PR6B	2	C	
D15	PR6A	2	T	RDQS6	PR6A	2	T	RDQS6
F14	PR5B	2	C		PR5B	2	C	
E14	PR5A	2	T		PR5A	2	T	

LFEC3 and LFECP/EC6 Logic Signal Connections: 256 fpBGA (Cont.)

Ball Number	LFEC3				LFECP6/LFEC6			
	Ball Function	Bank	LVDS	Dual Function	Ball Function	Bank	LVDS	Dual Function
D7	PT11B	0	C		PT11B	0	C	
C7	PT11A	0	T		PT11A	0	T	
A7	PT10B	0	C		PT10B	0	C	
A6	PT10A	0	T		PT10A	0	T	
E7	PT9B	0	C		PT9B	0	C	
GND	GND0	0			GND0	0		
E6	PT9A	0	T		PT9A	0	T	
D6	PT8B	0	C		PT8B	0	C	
C6	PT8A	0	T		PT8A	0	T	
B6	PT7B	0	C		PT7B	0	C	
B5	PT7A	0	T		PT7A	0	T	
A5	PT6B	0	C		PT6B	0	C	
A4	PT6A	0	T	TDQS6	PT6A	0	T	TDQS6
A3	PT5B	0	C		PT5B	0	C	
A2	PT5A	0	T		PT5A	0	T	
B2	PT4B	0	C		PT4B	0	C	
B3	PT4A	0	T		PT4A	0	T	
D5	PT3B	0	C		PT3B	0	C	
C5	PT3A	0	T		PT3A	0	T	
C4	PT2B	0	C		PT2B	0	C	
B4	PT2A	0	T		PT2A	0	T	
GND	GND0	0			GND0	0		
A1	GND	-			GND	-		
A16	GND	-			GND	-		
G10	GND	-			GND	-		
G7	GND	-			GND	-		
G8	GND	-			GND	-		
G9	GND	-			GND	-		
H10	GND	-			GND	-		
H7	GND	-			GND	-		
H8	GND	-			GND	-		
H9	GND	-			GND	-		
J10	GND	-			GND	-		
J7	GND	-			GND	-		
J8	GND	-			GND	-		
J9	GND	-			GND	-		
K10	GND	-			GND	-		
K7	GND	-			GND	-		
K8	GND	-			GND	-		
K9	GND	-			GND	-		
T1	GND	-			GND	-		
T16	GND	-			GND	-		
E12	VCC	-			VCC	-		

LFEC3 and LFECP/EC6 Logic Signal Connections: 256 fpBGA (Cont.)

Ball Number	LFEC3				LFECP6/LFEC6			
	Ball Function	Bank	LVDS	Dual Function	Ball Function	Bank	LVDS	Dual Function
E5	VCC	-			VCC	-		
E8	VCC	-			VCC	-		
M12	VCC	-			VCC	-		
M5	VCC	-			VCC	-		
M9	VCC	-			VCC	-		
B15	VCCAUX	-			VCCAUX	-		
R2	VCCAUX	-			VCCAUX	-		
F7	VCCIO0	0			VCCIO0	0		
F8	VCCIO0	0			VCCIO0	0		
F10	VCCIO1	1			VCCIO1	1		
F9	VCCIO1	1			VCCIO1	1		
G11	VCCIO2	2			VCCIO2	2		
H11	VCCIO2	2			VCCIO2	2		
J11	VCCIO3	3			VCCIO3	3		
K11	VCCIO3	3			VCCIO3	3		
L10	VCCIO4	4			VCCIO4	4		
L9	VCCIO4	4			VCCIO4	4		
L7	VCCIO5	5			VCCIO5	5		
L8	VCCIO5	5			VCCIO5	5		
J6	VCCIO6	6			VCCIO6	6		
K6	VCCIO6	6			VCCIO6	6		
G6	VCCIO7	7			VCCIO7	7		
H6	VCCIO7	7			VCCIO7	7		
F6	VCC	-			VCC	-		
F11	VCC	-			VCC	-		
L11	VCC	-			VCC	-		
L6	VCC	-			VCC	-		

LFEC20/EC20 and LFEC20/EC33 Logic Signal Connections: 484 fpBGA (Cont.)

LFEC20/LFEC20					LFEC20/LFEC33				
Ball Number	Ball Function	Bank	LVD S	Dual Function	Ball Number	Ball Function	Bank	LVD S	Dual Function
U9	PB20B	5	C		U9	PB20B	5	C	
Y8	PB21A	5	T		Y8	PB21A	5	T	
GND	GND5	5			GND	GND5	5		
Y9	PB21B	5	C		Y9	PB21B	5	C	
V9	PB22A	5	T	BDQS22	V9	PB22A	5	T	BDQS22
T9	PB22B	5	C		T9	PB22B	5	C	
W10	PB23A	5	T		W10	PB23A	5	T	
U10	PB23B	5	C		U10	PB23B	5	C	
V10	PB24A	5	T		V10	PB24A	5	T	
T10	PB24B	5	C		T10	PB24B	5	C	
AA6	PB25A	5	T		AA6	PB25A	5	T	
GND	GND5	5			GND	GND5	5		
AB5	PB25B	5	C		AB5	PB25B	5	C	
AA8	PB26A	5	T		AA8	PB26A	5	T	
AA7	PB26B	5	C		AA7	PB26B	5	C	
AB6	PB27A	5	T		AB6	PB27A	5	T	
AB7	PB27B	5	C		AB7	PB27B	5	C	
Y10	PB28A	5	T		Y10	PB28A	5	T	
W11	PB28B	5	C		W11	PB28B	5	C	
AB8	PB29A	5	T		AB8	PB29A	5	T	
GND	GND5	5			GND	GND5	5		
AB9	PB29B	5	C		AB9	PB29B	5	C	
AA10	PB30A	5	T	BDQS30	AA10	PB30A	5	T	BDQS30
AA9	PB30B	5	C		AA9	PB30B	5	C	
Y11	PB31A	5	T		Y11	PB31A	5	T	
AA11	PB31B	5	C		AA11	PB31B	5	C	
V11	PB32A	5	T	VREF2_5	V11	PB32A	5	T	VREF2_5
V12	PB32B	5	C	VREF1_5	V12	PB32B	5	C	VREF1_5
AB10	PB33A	5	T	PCLKT5_0	AB10	PB33A	5	T	PCLKT5_0
GND	GND5	5			GND	GND5	5		
AB11	PB33B	5	C	PCLKC5_0	AB11	PB33B	5	C	PCLKC5_0
Y12	PB34A	4	T	WRITEN	Y12	PB34A	4	T	WRITEN
U11	PB34B	4	C	CS1N	U11	PB34B	4	C	CS1N
W12	PB35A	4	T	VREF1_4	W12	PB35A	4	T	VREF1_4
U12	PB35B	4	C	CSN	U12	PB35B	4	C	CSN
W13	PB36A	4	T	VREF2_4	W13	PB36A	4	T	VREF2_4
U13	PB36B	4	C	D0/SPID7	U13	PB36B	4	C	D0/SPID7
AA12	PB37A	4	T	D2/SPID5	AA12	PB37A	4	T	D2/SPID5
GND	GND4	4			GND	GND4	4		
AB12	PB37B	4	C	D1/SPID6	AB12	PB37B	4	C	D1/SPID6
T13	PB38A	4	T	BDQS38	T13	PB38A	4	T	BDQS38
V13	PB38B	4	C	D3/SPID4	V13	PB38B	4	C	D3/SPID4
W14	PB39A	4	T		W14	PB39A	4	T	
U14	PB39B	4	C	D4/SPID3	U14	PB39B	4	C	D4/SPID3

LFEC20/EC20 and LFEC20/EC33 Logic Signal Connections: 484 fpBGA (Cont.)

LFEC20/LFEC20					LFEC20/LFEC33				
Ball Number	Ball Function	Bank	LVD S	Dual Function	Ball Number	Ball Function	Bank	LVD S	Dual Function
A17	PT47A	1	T		A17	PT47A	1	T	
B15	PT46B	1	C		B15	PT46B	1	C	
A16	PT46A	1	T	TDQS46	A16	PT46A	1	T	TDQS46
A15	PT45B	1	C		A15	PT45B	1	C	
GND	GND1	1			GND	GND1	1		
A14	PT45A	1	T		A14	PT45A	1	T	
G14	PT44B	1	C		G14	PT44B	1	C	
E15	PT44A	1	T		E15	PT44A	1	T	
D15	PT43B	1	C		D15	PT43B	1	C	
C15	PT43A	1	T		C15	PT43A	1	T	
C14	PT42B	1	C		C14	PT42B	1	C	
B14	PT42A	1	T		B14	PT42A	1	T	
A13	PT41B	1	C		A13	PT41B	1	C	
GND	GND1	1			GND	GND1	1		
B13	PT41A	1	T		B13	PT41A	1	T	
E14	PT40B	1	C		E14	PT40B	1	C	
C13	PT40A	1	T		C13	PT40A	1	T	
F14	PT39B	1	C		F14	PT39B	1	C	
D14	PT39A	1	T		D14	PT39A	1	T	
E13	PT38B	1	C		E13	PT38B	1	C	
G13	PT38A	1	T	TDQS38	G13	PT38A	1	T	TDQS38
A12	PT37B	1	C		A12	PT37B	1	C	
GND	GND1	1			GND	GND1	1		
B12	PT37A	1	T		B12	PT37A	1	T	
F13	PT36B	1	C		F13	PT36B	1	C	
D13	PT36A	1	T		D13	PT36A	1	T	
F12	PT35B	1	C	VREF2_1	F12	PT35B	1	C	VREF2_1
D12	PT35A	1	T	VREF1_1	D12	PT35A	1	T	VREF1_1
F11	PT34B	1	C		F11	PT34B	1	C	
C12	PT34A	1	T		C12	PT34A	1	T	
A11	PT33B	0	C	PCLKC0_0	A11	PT33B	0	C	PCLKC0_0
GND	GND0	0			GND	GND0	0		
A10	PT33A	0	T	PCLKT0_0	A10	PT33A	0	T	PCLKT0_0
E12	PT32B	0	C	VREF1_0	E12	PT32B	0	C	VREF1_0
E11	PT32A	0	T	VREF2_0	E11	PT32A	0	T	VREF2_0
B11	PT31B	0	C		B11	PT31B	0	C	
C11	PT31A	0	T		C11	PT31A	0	T	
B9	PT30B	0	C		B9	PT30B	0	C	
B10	PT30A	0	T	TDQS30	B10	PT30A	0	T	TDQS30
A9	PT29B	0	C		A9	PT29B	0	C	
GND	GND0	0			GND	GND0	0		
A8	PT29A	0	T		A8	PT29A	0	T	
D11	PT28B	0	C		D11	PT28B	0	C	
C10	PT28A	0	T		C10	PT28A	0	T	

LFECP/EC20, LFECP/EC33 Logic Signal Connections: 672 fpBGA (Cont.)

LFEC20/LFECP20					LFECP/EC33				
Ball Number	Ball Function	Bank	LVDS	Dual Function	Ball Number	Ball Function	Bank	LVDS	Dual Function
E24	NC	-			E24	PR8B	2	C	
D24	NC	-			D24	PR8A	2	T	
E22	NC	-			E22	PR7B	2	C	
F22	NC	-			F22	PR7A	2	T	
E21	NC	-			E21	PR6B	2	C	
D22	NC	-			D22	PR6A	2	T	RDQS6
E23	PR2B	2	C	VREF1_2	E23	PR2B	2	C	VREF1_2
D23	PR2A	2	T	VREF2_2	D23	PR2A	2	T	VREF2_2
GND	GND2	2			GND	GND2	2		
GND	GND1	1			GND	GND1	1		
G20	NC	-			G20	PT65B	1	C	
F20	NC	-			F20	PT65A	1	T	
D21	NC	-			D21	PT64B	1	C	
C21	NC	-			C21	PT64A	1	T	
C23	NC	-			C23	PT63B	1	C	
C22	NC	-			C22	PT63A	1	T	
B23	NC	-			B23	PT62B	1	C	
C24	NC	-			C24	PT62A	1	T	TDQS62
D20	NC	-			D20	PT61B	1	C	
-	-	-			GND	GND1	1		
E19	NC	-			E19	PT61A	1	T	
B25	NC	-			B25	PT60B	1	C	
B24	NC	-			B24	PT60A	1	T	
B26	NC	-			B26	PT59B	1	C	
A25	NC	-			A25	PT59A	1	T	
C20	NC	-			C20	PT58B	1	C	
C19	NC	-			C19	PT58A	1	T	
A24	PT57B	1	C		A24	PT57B	1	C	
-	-	-			GND	GND1	1		
A23	PT57A	1	T		A23	PT57A	1	T	
E18	PT56B	1	C		E18	PT56B	1	C	
D19	PT56A	1	T		D19	PT56A	1	T	
F19	PT55B	1	C		F19	PT55B	1	C	
B22	PT55A	1	T		B22	PT55A	1	T	
G19	PT54B	1	C		G19	PT54B	1	C	
B21	PT54A	1	T	TDQS54	B21	PT54A	1	T	TDQS54
D18	PT53B	1	C		D18	PT53B	1	C	
GND	GND1	1			GND	GND1	1		
C18	PT53A	1	T		C18	PT53A	1	T	
F18	PT52B	1	C		F18	PT52B	1	C	
A22	PT52A	1	T		A22	PT52A	1	T	
G18	PT51B	1	C		G18	PT51B	1	C	

LFECP/EC20, LFECP/EC33 Logic Signal Connections: 672 fpBGA (Cont.)

LFEC20/LFECP20					LFECP/EC33				
Ball Number	Ball Function	Bank	LVDS	Dual Function	Ball Number	Ball Function	Bank	LVDS	Dual Function
A5	PT13B	0	C		A5	PT13B	0	C	
GND	GND0	0			GND	GND0	0		
A4	PT13A	0	T		A4	PT13A	0	T	
F9	PT12B	0	C		F9	PT12B	0	C	
B6	PT12A	0	T		B6	PT12A	0	T	
E9	PT11B	0	C		E9	PT11B	0	C	
C8	PT11A	0	T		C8	PT11A	0	T	
G8	PT10B	0	C		G8	PT10B	0	C	
B5	PT10A	0	T		B5	PT10A	0	T	
A3	PT9B	0	C		A3	PT9B	0	C	
GND	GND0	0			GND	GND0	0		
A2	PT9A	0	T		A2	PT9A	0	T	
F8	PT8B	0	C		F8	PT8B	0	C	
B4	PT8A	0	T		B4	PT8A	0	T	
E8	PT7B	0	C		E8	PT7B	0	C	
B3	PT7A	0	T		B3	PT7A	0	T	
D8	PT6B	0	C		D8	PT6B	0	C	
G7	PT6A	0	T	TDQS6	G7	PT6A	0	T	TDQS6
C4	PT5B	0	C		C4	PT5B	0	C	
C5	PT5A	0	T		C5	PT5A	0	T	
E7	PT4B	0	C		E7	PT4B	0	C	
D4	PT4A	0	T		D4	PT4A	0	T	
F7	PT3B	0	C		F7	PT3B	0	C	
D6	PT3A	0	T		D6	PT3A	0	T	
D7	PT2B	0	C		D7	PT2B	0	C	
E6	PT2A	0	T		E6	PT2A	0	T	
GND	GND0	0			GND	GND0	0		
K10	GND	-			K10	GND	-		
K11	GND	-			K11	GND	-		
K12	GND	-			K12	GND	-		
K13	GND	-			K13	GND	-		
K14	GND	-			K14	GND	-		
K15	GND	-			K15	GND	-		
K16	GND	-			K16	GND	-		
L10	GND	-			L10	GND	-		
L11	GND	-			L11	GND	-		
L12	GND	-			L12	GND	-		
L13	GND	-			L13	GND	-		
L14	GND	-			L14	GND	-		
L15	GND	-			L15	GND	-		
L16	GND	-			L16	GND	-		
L17	GND	-			L17	GND	-		

LatticeECP Industrial (Continued)

Part Number	I/Os	Grade	Package	Pins	Temp.	LUTs
LFCEP20E-3F672I	400	-3	fpBGA	672	IND	19.7K
LFCEP20E-4F672I	400	-4	fpBGA	672	IND	19.7K
LFCEP20E-3F484I	360	-3	fpBGA	484	IND	19.7K
LFCEP20E-4F484I	360	-4	fpBGA	484	IND	19.7K

Part Number	I/Os	Grade	Package	Pins	Temp.	LUTs
LFCEP33E-3F672I	496	-3	fpBGA	672	IND	32.8K
LFCEP33E-4F672I	496	-4	fpBGA	672	IND	32.8K
LFCEP33E-3F484I	360	-3	fpBGA	484	IND	32.8K
LFCEP33E-4F484I	360	-4	fpBGA	484	IND	32.8K